## 14 Gbps, $2 \times 2$ CROSSPOINT SWITCH WITH PROGRAMMABLE OUTPUT VOLTAGE

## Typical Applications

The HMC857LC5 is ideal for:

- SONET OC-192 and 10 GbE
- 16G Fiber Channel
- Networking \& Storage
- Dual 2:1 Selector
- 1:2 Fanout with Input Mux

Features<br>Supports High Data Rates: up to 14 Gbps<br>Differential or Single-Ended Inputs / Outputs<br>Fast Rise and Fall Times: 21 / 21 ps<br>Low Power Consumption: 345 mW typ.<br>Programmable Differential<br>Output Voltage Swing: 475-1200 mVp-p<br>Propagation Delay: 117 ps<br>Single Supply: -3.3 V<br>32 Lead Ceramic $5 \times 5 \mathrm{~mm}$ SMT Package: $25 \mathrm{~mm}^{2}$

## Functional Diagram



## General Description

The HMC857LC5 is a $2 x 2$ Crosspoint Switch designed to support data transmission rates of up to 14 Gbps and selector port operation up to 14 GHz . The selector routes the differential inputs to either one or both of the desired outputs upon assertion of the appropriately selected port.

All differential inputs to the HMC857LC5 are CML and terminated on-chip with 50 Ohms to the positive supply, GND, and may be DC or AC coupled. Outputs can be connected directly to a 50 Ohm groundterminated system or drive devices with CML logic input. The HMC857LC5 also features an output level control pin, VR, which allows for loss compensation or signal level optimization. The HMC857LC5 operates from a single -3.3 V supply and is available in ROHScompliant $3 \times 3 \mathrm{~mm}$ SMT package.

Electrical Specifications, $T_{A}=+25^{\circ} \mathrm{C}$, vee $=-3.3 \mathrm{~V}, \mathrm{vr}=0 \mathrm{~V}$

| Parameter | Conditions | Min. | Typ. | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Power Supply Voltage |  | -3.6 | -3.3 | -3.0 | V |
| Power Supply Current |  |  | 105 |  | mA |
| Maximum Data Rate |  |  | 14 |  | Gbps |
| Maximum Select Rate |  |  | 14 |  | GHz |
| Input Voltage Range |  | -1.5 |  | 0.5 | V |
| Input Differential Range |  | 0.1 |  | 2.0 | Vp-p |
| Input Return Loss | Frequency <20 GHz |  | 10 |  | dB |
| Output Amplitude | Single-Ended, peak-to-peak |  | 500 |  | mVp-p |
|  | Differential, peak-to-peak |  | 1000 |  | mVp-p |
| Output High Voltage |  |  | -10 |  | mV |
| Output Low Voltage |  |  | -510 |  | mV |

Electrical Specifications (continued)

| Parameter | Conditions | Min. | Typ. | Max |
| :--- | :---: | :---: | :---: | :---: |
| Output Rise / Fall Time | Differential, $20 \%-80 \%$ |  | 21 |  |
| Output Return Loss | Frequency $<22 \mathrm{GHz}$ |  | 10 |  |
| Random Jitter, Jr | rms $^{[1]}$ | 0.08 | 0.11 |  |
| Deterministic Jitter, Jd | peak-to-peak, $2^{15}-1$ PRBS input ${ }^{[1]}$ |  | ps rms |  |
| Propagation Delay, A or B to D ${ }_{\text {OUT }}$, td |  | 2 | $\mathrm{ps}, \mathrm{p}-\mathrm{p}$ |  |
| Propagation Delay Select to Data, tds |  |  | 117 | ps |
| Set Up \& Hold Time, $\mathrm{t}_{\text {SH }}$ |  |  | 114 | ps |

[1] Added jitter calculated by de-embedding the source's jitter at 13 Gbps, $2^{15}-1$ PRBS input.

DC Current vs. Supply Voltage [1][2]


## Output Differential Voltage

vs. Supply Voltage [1][2]


DC Current vs. VR ${ }^{[2][3]}$


Output Differential Voltage vs. VR ${ }^{[2][3]}$

[1] $\mathrm{VR}=0.0 \mathrm{~V}$
[2] Frequency $=13 \mathrm{GHz}$
[3] $\mathrm{Vee}=-3.3 \mathrm{~V}$

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Rise / Fall Time vs. Supply Voltage ${ }^{[1][2]}$


Select Input Return Loss vs. Frequency ${ }^{[1][3][4]}$


Output Return Loss vs. Frequency ${ }^{[1][3][4]}$

[1] VR $=0.0 \mathrm{~V}$
[2] Frequency $=13 \mathrm{GHz}$
[3] Vee $=-3.3 \mathrm{~V}$
[5] Device measured on evaluation board with port extensions

Rise / Fall Time vs. VR ${ }^{[2][3]}$


Data Input Return Loss vs. Frequency ${ }^{[1][3][4]}$


Response vs. Input Power [1] [3] [5]

[4] Device measured on evaluation board with gating

Isolation [1] [2] [3]


## Eye Diagram


[1] Test Conditions:
Waveform generated with a differential 400 mV Agilent N4903A J-Bert with a 13 Gbps PN $2^{15}-1$ signal.
Eye Diagram data presented on a Tektronix CSA 8000

## Timing Diagram


td $=$ propagation delay, $\mathbb{N}$ to Aout
tds $=$ propagation delay, Select to DataOut

## Truth Table

| Inputs |  | Outputs |
| :---: | :---: | :---: |
| SB | SA | DP |
| X | L | IN0 ->A |
| X | H | IN1 ->A |
| L | X | IN0 ->B |
| H | X | IN1 -> B |
| H = Positive voltage level <br> L = Negative voltage level |  |  |
| Notes: <br> D $~=~ D P ~-~ D N ~$ |  |  |
| INO = INOP - INON |  |  |
| IN1 = IN1P - IN1N |  |  |

[1] $\mathrm{VR}=0.0 \mathrm{~V}$
[2] Device measured on evaluation board with port extensions
[3] $\mathrm{Vee}=-3.3 \mathrm{~V}$

Absolute Maximum Ratings

| Power Supply Voltage (Vee) | -3.75 V to +0.5 V |
| :--- | :--- |
| Input Signals | -2.0 V to 0.5 V |
| Output Signals | -1.5 V to 0.5 V |
| Junction Temperature | $125^{\circ} \mathrm{C}$ |
| Continuous Pdiss $\left(\mathrm{T}=85^{\circ} \mathrm{C}\right.$ <br> (derate $33.0 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $85^{\circ} \mathrm{C}$ ) | 1.33 W |
| Thermal Resistance $\left(\mathrm{R}_{\text {th }}\right.$-j-p <br> Wage paddle | $30{ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Worst case device to package |  |
| Storage Temperature | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Operating Temperature | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| ESD Sensitivity (HBM) | Class 1 B |

## Outline Drawing

BOTTOM VIEW


NOTES:

1. PACKAGE BODY MATERIAL: ALUMINA
2. LEAD AND GROUND PADDLE PLATING:

30-80 MICROINCHES GOLD OVER 50 MICROINCHES MINIMUM NICKEL.
3. DIMENSIONS ARE IN INCHES [MILLIMETERS].
4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
5. PACKAGE WARP SHALL NOT EXCEED 0.05 mm DATUM -C-
6. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.
7. PADDLE MUST BE SOLDERED TO Vee.

## Package Information

| Part Number | Package Body Material | Lead Finish | MSL Rating | Package Marking ${ }^{[2]}$ |
| :---: | :---: | :---: | :---: | :---: |
| HMC857LC5 | Alumina, White | Gold over Nickel | MSL3 ${ }^{[1]}$ | H857 <br> XXXX |

[^0]For price, delivery and to place orders: Hittite Microwave Corporation, 2 Elizabeth Drive, Chelmsford, MA 01824 WITH PROGRAMMABLE OUTPUT VOLTAGE

## Pin Descriptions

| Pin Number | Function | Description | Interface Schematic |
| :---: | :---: | :---: | :---: |
| $\begin{gathered} 1,4,5,8,11,14 \\ 17,20,21,24 \end{gathered}$ | GND | Signal Grounds | $\underbrace{\text { OGND }}$ |
| $\begin{gathered} 2,3, \\ 6,7 \end{gathered}$ | $\begin{gathered} \ln 0+, \ln 0-, \\ \ln 1+, \ln 1- \end{gathered}$ | Differential Inputs: Current Mode Logic (CML) referenced to positive supply. |  |
| $\begin{aligned} & 9,10 \\ & 15,16 \end{aligned}$ | $\begin{aligned} & \text { SelB+, SelB-, } \\ & \text { SelA+, SelA- } \end{aligned}$ | Differential Select Inputs: Current Mode Logic (CML) referenced to positive supply. |  |
| $\begin{gathered} 12,13,25,29, \\ 32 \end{gathered}$ | N/C | No connection necessary. These pins may be connected to RF/DC ground without affecting performance. |  |
| $\begin{aligned} & 18,19, \\ & 22,23 \end{aligned}$ | OutB-, OutB+, <br> OutA-, OutA+ | Differential Outputs: Current Mode Logic (CML) referenced to positive supply. |  |
| 26, 31 | GND | Supply Ground | $\frac{\text { OGND }}{\underline{=}}$ |
| $\begin{gathered} \text { 27, } 30 \\ \text { Package Base } \end{gathered}$ | Vee | These pins and the exposed paddle must be connected to the negative voltage supply. |  |
| 28 | VR | Output level control. Output level may be increased or decreased by applying a voltage to VR per "Output Differential vs. VR" plot. | VRO—m |

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Evaluation PCB


List of Materials for Evaluation PCB $126968{ }^{[1]}$

| Item | Description |
| :--- | :--- |
| J1 - J6, J9- J14 | PCB Mount SMA RF Connectors |
| J15 - J20 | DC Pin |
| JP1 | 0.1 " Header with Shorting Jumper |
| C1, C2 | $4.7 \mu$ F Capacitor, Tantalum |
| C3 - C5 | 330 pF Capacitor, 0402 Pkg. |
| R1 | 10 Ohm Resistor, 0603 Pkg. |
| U1 | HMC857LC5 $2 \times 2$ Crossbar Switch |
| PCB [2] | 126966 Evaluation Board |

[1] Reference this number when ordering complete evaluation PCB
[2] Circuit Board Material: Arlon 25FR or Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads should be connected directly to the ground plane similar to that shown. The exposed package base should be connected to Vee. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request. Install jumper on JP1 to short VR to GND for normal operation.

## Application Circuit



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 MAX9152EUE+


[^0]:    [1] Max peak reflow temperature of $260^{\circ} \mathrm{C}$
    [2] 4-Digit lot number XXXX

